

## AD6645

### FEATURES

**SNR = 75 dB,  $f_{IN}$  15 MHz up to 105 MSPS**  
**SNR = 72 dB,  $f_{IN}$  200 MHz up to 105 MSPS**  
**SFDR = 89 dBc,  $f_{IN}$  70 MHz up to 105 MSPS**  
**100 dB Multitone SFDR**  
**IF Sampling to 200 MHz**  
**Sampling Jitter 0.1 ps**  
**1.5 W Power Dissipation**  
**Differential Analog Inputs**  
**Pin Compatible to AD6644**  
**Twos Complement Digital Output Format**  
**3.3 V CMOS Compatible**  
**DataReady for Output Latching**

### APPLICATIONS

**Multichannel, Multimode Receivers**  
**Base Station Infrastructure**  
**AMPS, IS-136, CDMA, GSM, WCDMA**  
**Single Channel Digital Receivers**  
**Antenna Array Processing**  
**Communications Instrumentation**  
**Radar, Infrared Imaging**  
**Instrumentation**

### PRODUCT DESCRIPTION

The AD6645 is a high speed, high performance, monolithic 14-bit analog-to-digital converter. All necessary functions, including track-and-hold (T/H) and reference, are included on the chip to provide a complete conversion solution. The AD6645 provides CMOS compatible digital outputs. It is the fourth generation in a wideband ADC family, preceded by the AD9042 (12-bit, 41 MSPS),

the AD6640 (12-bit, 65 MSPS, IF sampling), and the AD6644 (14-bit, 40 MSPS/65 MSPS).

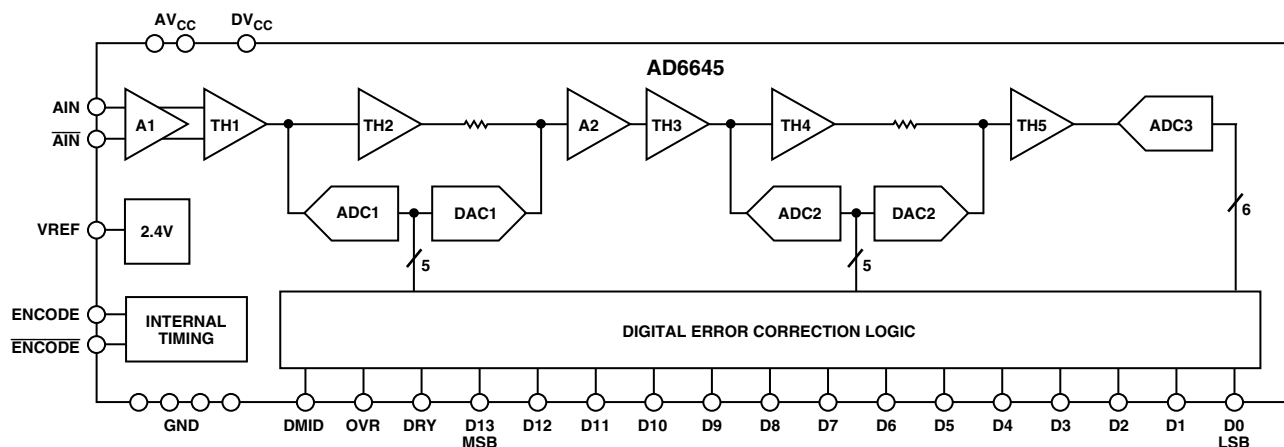
Designed for multichannel, multimode receivers, the AD6645 is part of Analog Devices' SoftCell<sup>®</sup> transceiver chipset. The AD6645 maintains 100 dB multitone, spurious-free dynamic range (SFDR) through the second Nyquist band. This breakthrough performance eases the burden placed on multimode digital receivers (software radios) that are typically limited by the ADC. Noise performance is exceptional; typical signal-to-noise ratio is 74.5 dB through the first Nyquist band.

The AD6645 is built on Analog Devices' high speed complementary bipolar process (XFCB) and uses an innovative, multipass circuit architecture. Units are available in a thermally enhanced 52-lead PowerQuad 4<sup>®</sup> (LQFP\_PQ4) specified from -40°C to +85°C at 80 MSPS and -10°C to +85°C at 105 MSPS.

### PRODUCT HIGHLIGHTS

- IF Sampling**  
 The AD6645 maintains outstanding ac performance up to input frequencies of 200 MHz, suitable for multicarrier 3G wideband cellular IF sampling receivers.
- Pin Compatibility**  
 The ADC has the same footprint and pin layout as the AD6644, 14-Bit 40 MSPS/65 MSPS ADC.
- SFDR Performance and Oversampling**  
 Multitone SFDR performance of -100 dBc can reduce the requirements of high end RF components and allows the use of receive signal processors such as the AD6620 or AD6624/AD6624A.

### FUNCTIONAL BLOCK DIAGRAM



### REV. B

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# AD6645—SPECIFICATIONS

## DC SPECIFICATIONS (AV<sub>CC</sub> = 5 V, DV<sub>CC</sub> = 3.3 V; T<sub>MIN</sub> and T<sub>MAX</sub> at rated speed grade, unless otherwise noted.)

| Parameter                                     | Temp | Test Level | AD6645ASQ-80 |       |      | AD6645ASQ-105 |      |      | Unit   |
|---|------|------------|--------------|-------|------|---------------|------|------|--------|
|   |      |            | Min          | Typ   | Max  | Min           | Typ  | Max  |        |
| RESOLUTION                                    |      |            | 14           |       |      |               |      |      | Bits   |
| ACCURACY                                      |      |            | Guaranteed   |       |      | Guaranteed    |      |      |        |
| No Missing Codes                              | Full | II         |              |       |      |               |      |      |        |
| Offset Error                                  | Full | II         | -10          | +1.2  | +10  | -10           | +1.2 | +10  | mV     |
| Gain Error                                    | Full | II         | -10          | 0     | +10  | -10           | 0    | +10  | % FS   |
| Differential Nonlinearity (DNL)               | Full | II         | -1.0         | ±0.25 | +1.5 | -1.0          | ±0.5 | +1.5 | LSB    |
| Integral Nonlinearity (INL)                   | Full | V          | ±0.5         |       |      | ±1.5          |      |      | LSB    |
| TEMPERATURE DRIFT                             |      |            |              |       |      |               |      |      |        |
| Offset Error                                  | Full | V          | 1.5          |       |      | 1.5           |      |      | ppm/°C |
| Gain Error                                    | Full | V          | 48           |       |      | 48            |      |      | ppm/°C |
| POWER SUPPLY REJECTION (PSRR)                 | 25°C | V          | ±1.0         |       |      | ±1.0          |      |      | mV/V   |
| REFERENCE OUT (VREF) <sup>1</sup>             | Full | V          | 2.4          |       |      | 2.4           |      |      | V      |
| ANALOG INPUTS (AIN, $\overline{\text{AIN}}$ ) |      |            |              |       |      |               |      |      |        |
| Differential Input Voltage Range              | Full | V          | 2.2          |       |      | 2.2           |      |      | V p-p  |
| Differential Input Resistance                 | Full | V          | 1            |       |      | 1             |      |      | kΩ     |
| Differential Input Capacitance                | 25°C | V          | 1.5          |       |      | 1.5           |      |      | pF     |
| POWER SUPPLY                                  |      |            |              |       |      |               |      |      |        |
| Supply Voltages                               |      |            |              |       |      |               |      |      |        |
| AV <sub>CC</sub>                              | Full | II         | 4.75         | 5.0   | 5.25 | 4.75          | 5.0  | 5.25 | V      |
| DV <sub>CC</sub>                              | Full | II         | 3.0          | 3.3   | 3.6  | 3.0           | 3.3  | 3.6  | V      |
| Supply Current                                |      |            |              |       |      |               |      |      |        |
| I AV <sub>CC</sub> (AV <sub>CC</sub> = 5.0 V) | Full | II         | 275          |       | 320  | 275           |      | 320  | mA     |
| I DV <sub>CC</sub> (DV <sub>CC</sub> = 3.3 V) | Full | II         | 32           |       | 45   | 32            |      | 45   | mA     |
| Rise Time <sup>2</sup>                        |      |            |              |       |      |               |      |      |        |
| AV <sub>CC</sub>                              | Full | IV         | 250          |       |      | 250           |      |      | ms     |
| POWER CONSUMPTION                             | Full | II         | 1.5          |       | 1.75 | 1.5           |      | 1.75 | W      |

### NOTES

<sup>1</sup>VREF is provided for setting the common-mode offset of a differential amplifier such as the AD8138 when a dc-coupled analog input is required. VREF should be buffered if used to drive additional circuit functions.

<sup>2</sup>Specified for dc supplies with linear rise time characteristics.

Specifications subject to change without notice

## DIGITAL SPECIFICATIONS (AV<sub>CC</sub> = 5 V, DV<sub>CC</sub> = 3.3 V; T<sub>MIN</sub> and T<sub>MAX</sub> at rated speed grade, unless otherwise noted.)

| Parameter (Conditions)                                  | Temp | Test Level | AD6645ASQ-80        |     |                     | AD6645ASQ-105       |     |                     | Unit  |
|---|------|------------|---------------------|-----|---------------------|---------------------|-----|---------------------|-------|
|   |      |            | Min                 | Typ | Max                 | Min                 | Typ | Max                 |       |
| ENCODE INPUTS (ENC, $\overline{\text{ENC}}$ )           |      |            |                     |     |                     |                     |     |                     |       |
| Differential Input Voltage <sup>1</sup>                 | Full | IV         | 0.4                 |     |                     | 0.4                 |     |                     | V p-p |
| Differential Input Resistance                           | 25°C | V          | 10                  |     |                     | 10                  |     |                     | kΩ    |
| Differential Input Capacitance                          | 25°C | V          | 2.5                 |     |                     | 2.5                 |     |                     | pF    |
| LOGIC OUTPUTS (D13–D0, DRY, OVR <sup>2</sup> )          |      |            |                     |     |                     |                     |     |                     |       |
| Logic Compatibility                                     |      |            | CMOS                |     |                     | CMOS                |     |                     |       |
| Logic 1 Voltage (DV <sub>CC</sub> = 3.3 V) <sup>3</sup> | Full | II         | 2.85                |     | DV <sub>CC</sub> -2 | 2.85                |     | DV <sub>CC</sub> -2 | V     |
| Logic 0 Voltage (DV <sub>CC</sub> = 3.3 V) <sup>3</sup> | Full | II         |                     |     | 0.2 0.5             |                     |     | 0.2 0.5             | V     |
| Output Coding   |      |            | Twos Complement     |     |                     | Twos Complement     |     |                     |       |
| DMID  | Full | V          | DV <sub>CC</sub> /2 |     |                     | DV <sub>CC</sub> /2 |     |                     | V     |

### NOTES

<sup>1</sup>All ac specifications tested by driving ENCODE and  $\overline{\text{ENCODE}}$  differentially.

<sup>2</sup>The functionality of the Overrange bit is specified for a temperature range of 25°C to 85°C only.

<sup>3</sup>Digital output logic levels: DV<sub>CC</sub> = 3.3 V, C<sub>LOAD</sub> = 10 pF. Capacitive loads >10 pF will degrade performance.

Specifications subject to change without notice.

## AC SPECIFICATIONS<sup>1</sup> (AV<sub>CC</sub> = 5 V, DV<sub>CC</sub> = 3.3 V; ENCODE, $\overline{\text{ENCODE}}$ , T<sub>MIN</sub> and T<sub>MAX</sub> at rated speed grade, unless otherwise noted.)

| Parameter (Conditions)                 | Temp                    | Test Level | AD6645ASQ-80 |      |      | AD6645ASQ-105 |      |     | Unit |
|--|-------------------------|------------|--------------|------|------|---------------|------|-----|------|
|  |                         |            | Min          | Typ  | Max  | Min           | Typ  | Max |      |
| SNR                                    |                         |            |              |      |      |               |      |     |      |
| Analog Input                           | 15.5 MHz                | 25°C       | V            |      | 75.0 |               | 75.0 |     | dB   |
| @ -1 dBFS                              | 30.5 MHz                | Full       | II           | 72.5 | 74.5 |               |      |     | dB   |
|  | 37.7 MHz                | 25°C       | I            |      |      | 72.5          | 74.5 |     | dB   |
|  | 70.0 MHz                | Full       | II           | 72.0 | 73.5 | 72.0          | 73.5 |     | dB   |
|  | 150.0 MHz               | 25°C       | V            |      | 73.0 |               | 73.0 |     | dB   |
|  | 200.0 MHz               | 25°C       | V            |      | 72.0 |               | 72.0 |     | dB   |
| SINAD                                  |                         |            |              |      |      |               |      |     |      |
| Analog Input                           | 15.5 MHz                | 25°C       | V            |      | 75.0 |               | 75.0 |     | dB   |
| @ -1 dBFS                              | 30.5 MHz                | Full       | II           | 72.5 | 74.5 |               |      |     | dB   |
|  | 37.7 MHz                | 25°C       | I            |      |      | 72.5          | 74.5 |     | dB   |
|  | 70.0 MHz                | Full       | V            |      | 73.0 |               | 73.0 |     | dB   |
|  | 150.0 MHz               | 25°C       | V            |      | 68.5 |               | 67.5 |     | dB   |
|  | 200.0 MHz               | 25°C       | V            |      | 62.5 |               | 62.5 |     | dB   |
| WORST HARMONIC (Second or Third)       |                         |            |              |      |      |               |      |     |      |
| Analog Input                           | 15.5 MHz                | 25°C       | V            |      | 93.0 |               | 93.1 |     | dBc  |
| @ -1 dBFS                              | 30.5 MHz                | Full       | II           | 85.0 | 93.0 |               |      |     | dBc  |
|  | 37.7 MHz                | 25°C       | I            |      |      | 85.0          | 93.0 |     | dBc  |
|  | 70.0 MHz                | Full       | V            |      | 89.0 |               | 87.0 |     | dBc  |
|  | 150.0 MHz               | 25°C       | V            |      | 70.0 |               | 70.0 |     | dBc  |
|  | 200.0 MHz               | 25°C       | V            |      | 63.5 |               | 63.5 |     | dBc  |
| WORST HARMONIC (Fourth or Higher)      |                         |            |              |      |      |               |      |     |      |
| Analog Input                           | 15.5 MHz                | 25°C       | V            |      | 96.0 |               | 96.0 |     | dBc  |
| @ -1 dBFS                              | 30.5 MHz                | Full       | II           | 85.0 | 95.0 |               |      |     | dBc  |
|  | 37.7 MHz                | 25°C       | I            |      |      | 86.0          | 95.0 |     | dBc  |
|  | 70.0 MHz                | Full       | V            |      | 90.0 |               | 90.0 |     | dBc  |
|  | 150.0 MHz               | 25°C       | V            |      | 90.0 |               | 90.0 |     | dBc  |
|  | 200.0 MHz               | 25°C       | V            |      | 88.0 |               | 88.0 |     | dBc  |
| TWO TONE SFDR @30.5 MHz <sup>2,3</sup> |                         | 25°C       | V            |      | 100  |               | 98.0 |     | dBFS |
|  | 55.0 MHz <sup>2,4</sup> | 25°C       | V            |      | 100  |               | 98.0 |     | dBFS |
|  | 70.0 MHz <sup>2,5</sup> | 25°C       | V            |      |      |               | 98.0 |     | dBFS |
| TWO TONE IMD REJECTION <sup>3,4</sup>  |                         |            |              |      |      |               |      |     |      |
| F1, F2 @ -7 dBFS                       |                         | 25°C       | V            |      | 90   |               | 90   |     | dBc  |
| ANALOG INPUT BANDWIDTH                 |                         | 25°C       | V            |      | 270  |               | 270  |     | MHz  |

## NOTES

<sup>1</sup>All ac specifications tested by driving ENCODE and  $\overline{\text{ENCODE}}$  differentially.

<sup>2</sup>Analog input signal power swept from -10 dBFS to -100 dBFS.

<sup>3</sup>F1 = 30.5 MHz, F2 = 31.5 MHz.

<sup>4</sup>F1 = 55.25 MHz, F2 = 56.25 MHz.

<sup>5</sup>F1 = 69.1 MHz, F2 = 71.1 MHz.

Specifications subject to change without notice.

## SWITCHING SPECIFICATIONS (AV<sub>CC</sub> = 5 V, DV<sub>CC</sub> = 3.3 V; ENCODE, $\overline{\text{ENCODE}}$ , T<sub>MIN</sub> and T<sub>MAX</sub> at rated speed grade, unless otherwise noted.)

| Parameter (Conditions)                      | Temp | Test Level | AD6645ASQ-80 |     |     | AD6645ASQ-105 |     |     | Unit |
|---|------|------------|--------------|-----|-----|---------------|-----|-----|------|
|   |      |            | Min          | Typ | Max | Min           | Typ | Max |      |
| Maximum Conversion Rate                     | Full | II         | 80           |     |     | 105           |     |     | MSPS |
| Minimum Conversion Rate                     | Full | IV         |              |     | 30  |               |     |     | MSPS |
| ENCODE Pulswidth High (t <sub>ENCH</sub> )* | Full | IV         | 5.625        |     |     | 4.286         |     | 30  | ns   |
| ENCODE Pulswidth Low (t <sub>ENCL</sub> )*  | Full | IV         | 5.625        |     |     | 4.286         |     |     | ns   |

\*Several timing parameters are a function of t<sub>ENCL</sub> and t<sub>ENCH</sub>.

Specifications subject to change without notice.

# AD6645

## SWITCHING SPECIFICATIONS (continued)

( $AV_{CC} = 5\text{ V}$ ,  $DV_{CC} = 3.3\text{ V}$ ; ENCODE,  $\overline{\text{ENCODE}}$ ,  $T_{\text{MIN}}$  and  $T_{\text{MAX}}$  at rated speed grade,  $C_{\text{LOAD}} = 10\text{ pF}$ , unless otherwise noted.)

| Parameter (Conditions)                  | Name               | Temp | Test Level | AD6645ASQ-80 |  |  | AD6645ASQ-105 |  |  | Unit   |
|---|--------------------|------|------------|--------------|--|--|---------------|--|--|--------|
|   |                    |      |            | Min          | Typ                                      | Max                                      | Min           | Typ                                      | Max                                      |        |
| ENCODE Input Parameters <sup>1</sup>    |                    |      |            |              |  |  |               |  |  |        |
| Encode Period <sup>1</sup>              | $t_{\text{ENC}}$   | Full | V          |              | 12.5                                     |  |               | 9.5                                      |  | ns     |
| Encode Pulsewidth High <sup>2</sup>     | $t_{\text{ENCH}}$  | Full | V          |              | 6.25                                     |  |               | 4.75                                     |  | ns     |
| Encode Pulsewidth Low                   | $t_{\text{ENCL}}$  | Full | V          |              | 6.25                                     |  |               | 4.75                                     |  | ns     |
| ENCODE/DataReady                        |                    |      |            |              |  |  |               |  |  |        |
| Encode Rising to DataReady Falling      | $t_{\text{DR}}$    | Full | V          | 1.0          | 2.0                                      | 3.1                                      | 1.0           | 2.0                                      | 3.1                                      | ns     |
| Encode Rising to DataReady Rising       | $t_{\text{E\_DR}}$ | Full | V          |              | $t_{\text{ENCH}} + t_{\text{DR}}$        |  |               | $t_{\text{ENCH}} + t_{\text{DR}}$        |  | ns     |
| (50% Duty Cycle)                        |                    | Full | V          | 7.3          | 8.3                                      | 9.4                                      | 5.7           | 6.75                                     | 7.9                                      | ns     |
| ENCODE/DATA (D13:0), OVR                |                    |      |            |              |  |  |               |  |  |        |
| ENC to DATA Falling Low                 | $t_{\text{E\_FL}}$ | Full | V          | 2.4          | 4.7                                      | 7.0                                      | 2.4           | 4.7                                      | 7.0                                      | ns     |
| ENC to DATA Rising Low                  | $t_{\text{E\_RL}}$ | Full | V          | 1.4          | 3.0                                      | 4.7                                      | 1.4           | 3.0                                      | 4.7                                      | ns     |
| ENCODE to DATA Delay (Hold Time)        | $t_{\text{H\_E}}$  | Full | V          | 1.4          | 3.0                                      | 4.7                                      | 1.4           | 3.0                                      | 4.7                                      | ns     |
| ENCODE to DATA Delay (Setup Time)       | $t_{\text{S\_E}}$  | Full | V          |              | $t_{\text{ENC}} - t_{\text{E\_FL(max)}}$ |  |               | $t_{\text{ENC}} - t_{\text{E\_FL(max)}}$ |  | ns     |
|   |                    |      |            |              | $t_{\text{ENC}} - t_{\text{E\_FL(typ)}}$ |  |               | $t_{\text{ENC}} - t_{\text{E\_FL(typ)}}$ |  | ns     |
|   |                    |      |            |              |  | $t_{\text{ENC}} - t_{\text{E\_FL(min)}}$ |               |  | $t_{\text{ENC}} - t_{\text{E\_FL(min)}}$ | ns     |
| (50% Duty Cycle)                        |                    | Full | V          | 5.3          | 7.6                                      | 10.0                                     | 2.3           | 4.8                                      | 7.0                                      | ns     |
| DataReady (DRY <sup>3</sup> )/DATA, OVR |                    |      |            |              |  |  |               |  |  |        |
| DataReady to DATA Delay (Hold Time)     | $t_{\text{H\_DR}}$ | Full | V          |              | Note 4                                   |  |               | Note 4                                   |  |        |
| (50% Duty Cycle)                        |                    |      |            | 6.6          | 7.2                                      | 7.9                                      | 5.1           | 5.7                                      | 6.4                                      | ns     |
| DataReady to DATA Delay (Setup Time)    | $t_{\text{S\_DR}}$ | Full | V          |              | Note 4                                   |  |               | Note 4                                   |  |        |
| (50% Duty Cycle)                        |                    |      |            | 2.1          | 3.6                                      | 5.1                                      | 0.6           | 2.1                                      | 3.5                                      | ns     |
| APERTURE DELAY                          |                    |      |            |              |  |  |               |  |  |        |
|   | $t_{\text{A}}$     | 25°C | V          |              | -500                                     |  |               | -500                                     |  | ps     |
| APERTURE UNCERTAINTY (Jitter)           |                    |      |            |              |  |  |               |  |  |        |
|   | $t_{\text{J}}$     | 25°C | V          |              | 0.1                                      |  |               | 0.1                                      |  | ps rms |

### NOTES

<sup>1</sup>Several timing parameters are a function of  $t_{\text{ENC}}$  and  $t_{\text{ENCH}}$ .

<sup>2</sup>ENCODE TO DATA Delay (Hold Time) is the absolute minimum propagation delay through the analog-to-digital converter,  $t_{\text{E\_RL}} = t_{\text{H\_E}}$ .

<sup>3</sup>DRY is an inverted and delayed version of the encode clock. Any change in the duty cycle of the clock will correspondingly change the duty cycle of DRY.

<sup>4</sup>DataReady to DATA Delay ( $t_{\text{H\_DR}}$  and  $t_{\text{S\_DR}}$ ) is calculated relative to rated speed grade and is dependent on  $t_{\text{ENC}}$  and duty cycle.

Specifications subject to change without notice.

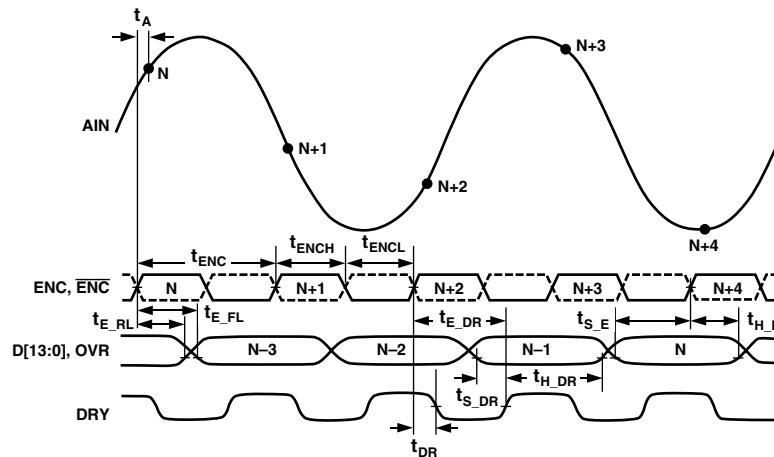


Figure 1. Timing Diagram

## ABSOLUTE MAXIMUM RATINGS\*

| Parameter                                  | Min | Max              | Unit |
|--|-----|------------------|------|
| <b>ELECTRICAL</b>                          |     |                  |      |
| AV <sub>CC</sub> Voltage                   | 0   | 7                | V    |
| DV <sub>CC</sub> Voltage                   | 0   | 7                | V    |
| Analog Input Voltage                       | 0   | AV <sub>CC</sub> | V    |
| Analog Input Current                       |     | 25               | mA   |
| Digital Input Voltage                      | 0   | AV <sub>CC</sub> | V    |
| Digital Output Current                     |     | 4                | mA   |
| <b>ENVIRONMENTAL</b>                       |     |                  |      |
| -80 Operating Temperature Range (Ambient)  | -40 | +85              | °C   |
| -105 Operating Temperature Range (Ambient) | -10 | +85              | °C   |
| Maximum Junction Temperature               |     | 150              | °C   |
| Lead Temperature (Soldering, 10 sec)       |     | 300              | °C   |
| Storage Temperature Range (Ambient)        | -65 | +150             | °C   |

\* Absolute maximum ratings are limiting values to be applied individually and beyond which the serviceability of the circuit may be impaired. Functional operability is not necessarily implied. Exposure to absolute maximum rating conditions for an extended period of time may affect device reliability.

## THERMAL CHARACTERISTICS

52-Lead Power Quad 4 LQFP\_PQ4

$\theta_{JA} = 23^{\circ}\text{C/W}$  Soldered Slug, No Airflow

$\theta_{JA} = 17^{\circ}\text{C/W}$  Soldered Slug, 200 LFPM Airflow

$\theta_{JA} = 30^{\circ}\text{C/W}$  Unsoldered Slug, No Airflow

$\theta_{JA} = 24^{\circ}\text{C/W}$  Unsoldered Slug, 200 LFPM Airflow

$\theta_{JC} = 2^{\circ}\text{C/W}$  Bottom of Package (Heatslug)

Typical 4-Layer JEDEC Board Horizontal Orientation

## EXPLANATION OF TEST LEVELS

### Test Level

- I. 100% production tested.
- II. 100% production tested at 25°C and guaranteed by design and characterization at temperature extremes.
- III. Sample tested only.
- IV. Parameter is guaranteed by design and characterization testing.
- V. Parameter is a typical value only.

## ORDERING GUIDE

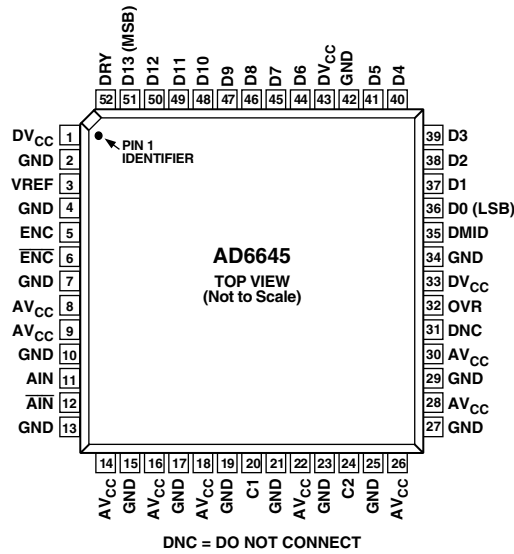
| Model          | Temperature Range        | Package Description            | Package Option |
|----------------|--------------------------|--------------------------------|----------------|
| AD6645ASQ-80   | -40°C to +85°C (Ambient) | 52-Lead PowerQuad 4 (LQFP_PQ4) | SQ-52          |
| AD6645ASQ-105  | -10°C to +85°C (Ambient) | 52-Lead PowerQuad 4 (LQFP_PQ4) | SQ-52          |
| AD6645-80/PCB  |                          | Evaluation Board               |                |
| AD6645-105/PCB |                          | Evaluation Board               |                |

## CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although the AD6645 features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



## PIN CONFIGURATION



## PIN FUNCTION DESCRIPTIONS

| Pin No.   | Mnemonic                | Function  |
|---|-------------------------|---|
| 1, 33, 43   | DV <sub>CC</sub>        | 3.3 V Power Supply (Digital) Output Stage Only.                             |
| 2, 4, 7, 10, 13, 15, 17, 19, 21, 23, 25, 27, 29, 34, 42 | GND                     | Ground.   |
| 3   | VREF                    | 2.4 V Reference. Bypass to ground with a 0.1 μF microwave chip capacitor.   |
| 5   | ENC                     | Encode Input. Conversion initiated on rising edge.                          |
| 6   | $\overline{\text{ENC}}$ | Complement of ENC, Differential Input.                                      |
| 8, 9, 14, 16, 18, 22, 26, 28, 30                        | AV <sub>CC</sub>        | 5 V Analog Power Supply.  |
| 11  | AIN                     | Analog Input.   |
| 12  | $\overline{\text{AIN}}$ | Complement of AIN, Differential Analog Input.                               |
| 20  | C1                      | Internal Voltage Reference. Bypass to ground with a 0.1 μF chip capacitor.  |
| 24  | C2                      | Internal Voltage Reference. Bypass to ground with a 0.1 μF chip capacitor.  |
| 31  | DNC                     | Do not connect this pin.  |
| 32  | OVR*                    | Overrange Bit. A logic level high indicates analog input exceeds ±FS.       |
| 35  | DMID                    | Output Data Voltage Midpoint. Approximately equal to (DV <sub>CC</sub> )/2. |
| 36  | D0 (LSB)                | Digital Output Bit (Least Significant Bit); Twos Complement.                |
| 37–41, 44–50  | D1–D5, D6–D12           | Digital Output Bits in Twos Complement.                                     |
| 51  | D13 (MSB)               | Digital Output Bit (Most Significant Bit); Twos Complement.                 |
| 52  | DRY                     | DataReady Output.   |

\*The functionality of the overrange bit is specified for a temperature range of 25°C to 85°C only.

## DEFINITIONS OF SPECIFICATIONS

### Analog Bandwidth

The analog input frequency at which the spectral power of the fundamental frequency (as determined by the FFT analysis) is reduced by 3 dB.

### Aperture Delay

The delay between the 50% point of the rising edge of the ENCODE command and the instant at which the analog input is sampled.

### Aperture Uncertainty (Jitter)

The sample-to-sample variation in aperture delay.

### Differential Analog Input Resistance, Differential Analog Input Capacitance, and Differential Analog Input Impedance

The real and complex impedances measured at each analog input port. The resistance is measured statically and the capacitance and differential input impedances are measured with a network analyzer.

### Differential Analog Input Voltage Range

The peak-to-peak differential voltage that must be applied to the converter to generate a full-scale response. Peak differential voltage is computed by observing the voltage on a single pin and subtracting the voltage from the other pin, which is 180 degrees out of phase. Peak-to-peak differential is computed by rotating the inputs' phase 180 degrees and taking the peak measurement again. Then the difference is computed between both peak measurements.

### Differential Nonlinearity

The deviation of any code width from an ideal 1 LSB step.

### Encode Pulsewidth/Duty Cycle

Pulsewidth high is the minimum amount of time that the ENCODE pulse should be left in Logic 1 state to achieve rated performance; pulsewidth low is the minimum time ENCODE pulse should be left in low state. See timing implications of changing  $t_{ENCH}$  in text. At a given clock rate, these specs define an acceptable ENCODE duty cycle.

### Full-Scale Input Power

Expressed in dBm. Computed using the following equation:

$$Power_{Full\ Scale} = 10 \log \left[ \frac{V_{Full\ Scale\ rms}^2}{|Z|_{Input} \cdot 0.001} \right]$$

### Harmonic Distortion, Second

The ratio of the rms signal amplitude to the rms value of the second harmonic component, reported in dBc.

### Harmonic Distortion, Third

The ratio of the rms signal amplitude to the rms value of the third harmonic component, reported in dBc.

### Integral Nonlinearity

The deviation of the transfer function from a reference line measured in fractions of 1 LSB using a best straight line determined by a least square curve fit.

### Minimum Conversion Rate

The encode rate at which the SNR of the lowest analog signal frequency drops by no more than 3 dB below the guaranteed limit.

### Maximum Conversion Rate

The encode rate at which parametric testing is performed.

### Noise (For Any Range Within the ADC)

$$V_{NOISE} = \sqrt{|Z| \times 0.001 \times 10^{\left(\frac{FS_{dBm} - SNR_{dBc} - Signal_{dBFS}}{10}\right)}}$$

Where  $Z$  is the input impedance,  $FS$  is the full scale of the device for the frequency in question;  $SNR$  is the value for the particular input level; and  $Signal$  is the signal level within the ADC reported in dB below full scale. This value includes both thermal and quantization noise.

### Output Propagation Delay

The delay between a differential crossing of ENCODE and  $\overline{ENCODE}$  and the time when all output data bits are within valid logic levels.

### Power Supply Rejection Ratio

The ratio of a change in input offset voltage to a change in power supply voltage.

### Power Supply Rise Time

The time from when the dc supply is initiated until the supply output reaches the minimum specified operating voltage for the ADC. The dc level is measured at the supply pin(s) of the ADC.

### Signal-to-Noise-and-Distortion (SINAD)

The ratio of the rms signal amplitude (set 1 dB below full scale) to the rms value of the sum of all other spectral components, including harmonics but excluding dc.

### Signal-to-Noise Ratio (without Harmonics)

The ratio of the rms signal amplitude (set at 1 dB below full scale) to the rms value of the sum of all other spectral components, excluding the first five harmonics and dc.

### Spurious-Free Dynamic Range (SFDR)

The ratio of the rms signal amplitude to the rms value of the peak spurious spectral component. The peak spurious component may or may not be a harmonic. May be reported in dBc (i.e., degrades as signal level is lowered) or dBFS (always related back to converter full scale).

### Two Tone Intermodulation Distortion Rejection

The ratio of the rms value of either input tone to the rms value of the worst third order intermodulation product; reported in dBc.

### Two Tone SFDR

The ratio of the rms value of either input tone to the rms value of the peak spurious component. The peak spurious component may or may not be an IMD product, may be reported in dBc (i.e., degrades as signal level is lowered) or in dBFS (always related back to converter full scale).

### Worst Other Spur

The ratio of the rms signal amplitude to the rms value of the worst spurious component (excluding the second and third harmonics) reported in dBc.

# AD6645

## EQUIVALENT CIRCUITS

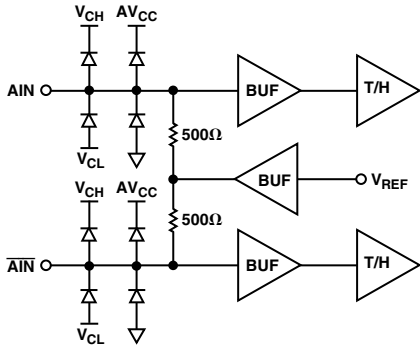


Figure 2. Analog Input Stage

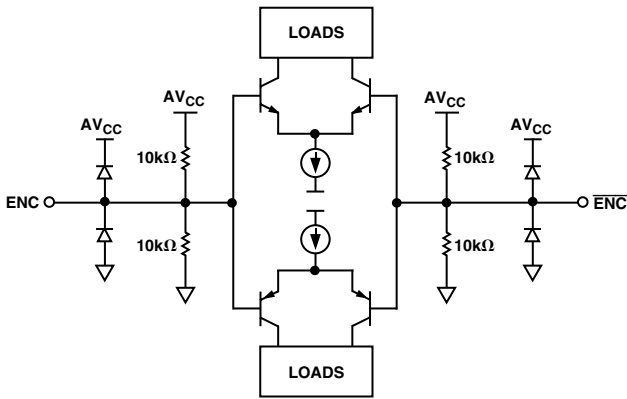


Figure 3. Encode Inputs

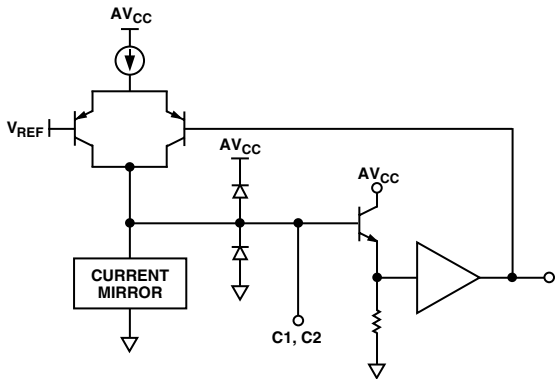


Figure 4. Compensation Pin, C1 or C2

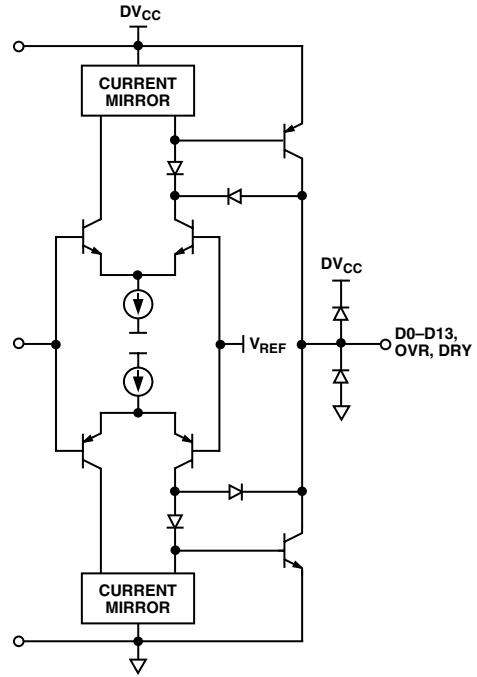


Figure 5. Digital Output Stage

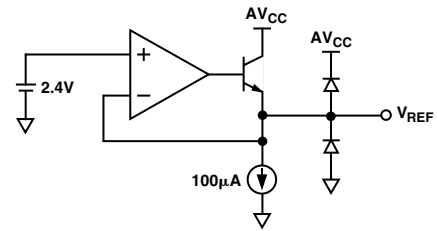


Figure 6. 2.4 V Reference

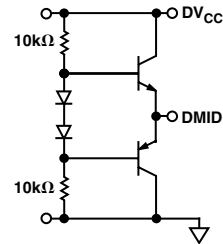
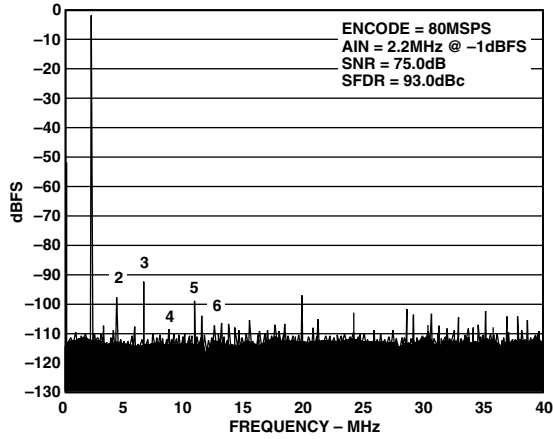


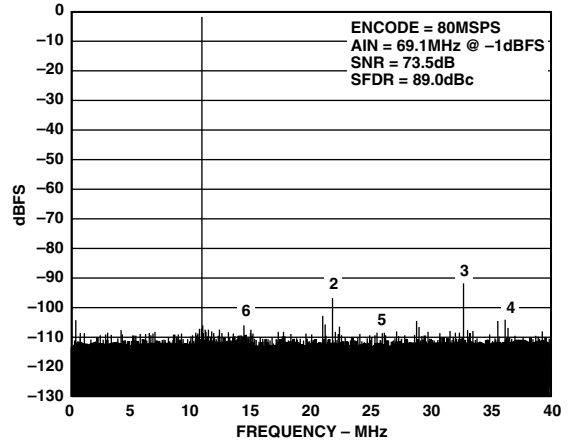
Figure 7. DMID Reference



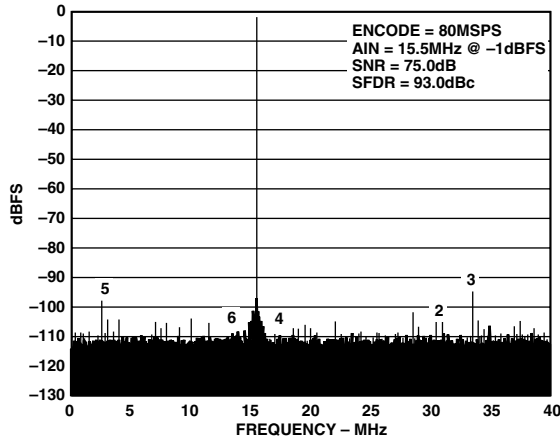
# Typical Performance Characteristics—AD6645



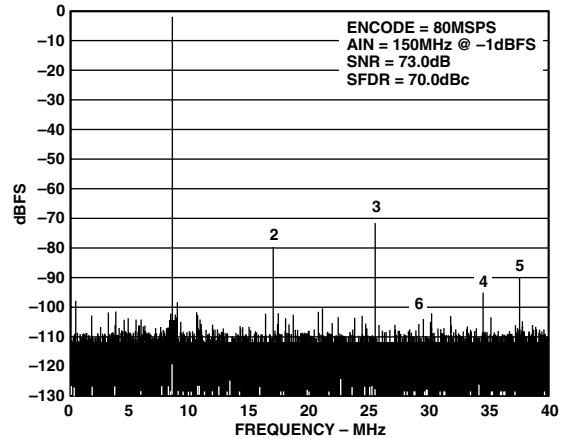
TPC 1. Single Tone @ 2.2 MHz



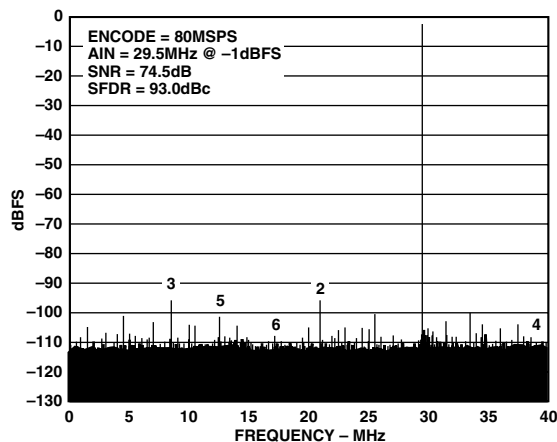
TPC 4. Single Tone @ 69.1 MHz



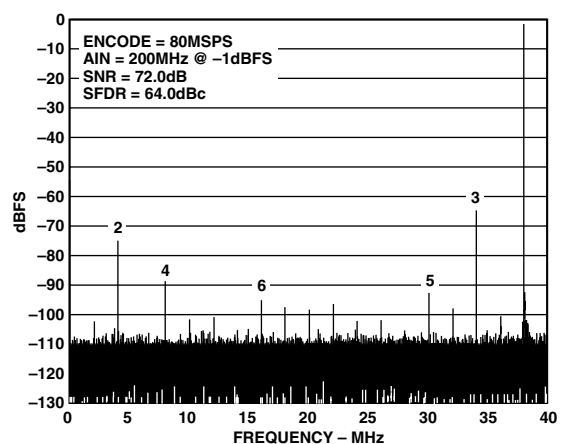
TPC 2. Single Tone @ 15.5 MHz



TPC 5. Single Tone @ 150 MHz

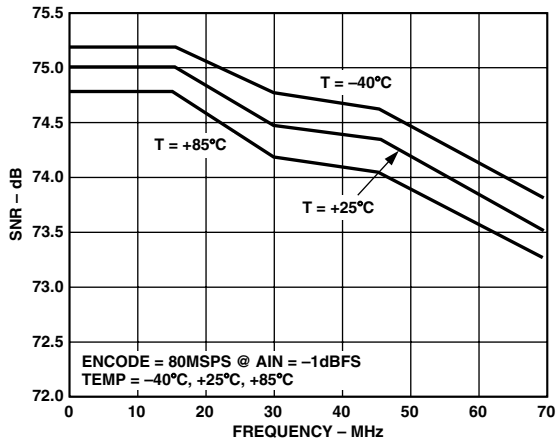


TPC 3. Single Tone @ 29.5 MHz

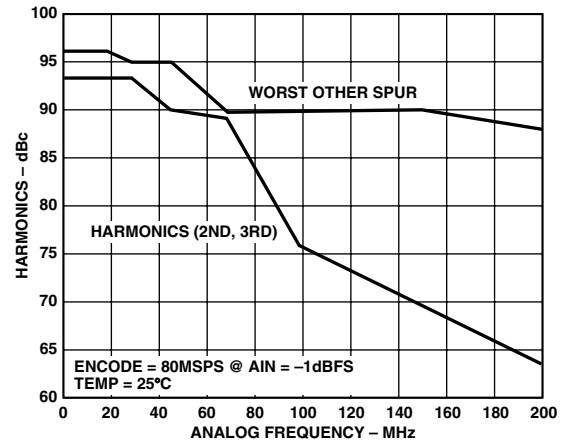


TPC 6. Single Tone @ 200 MHz

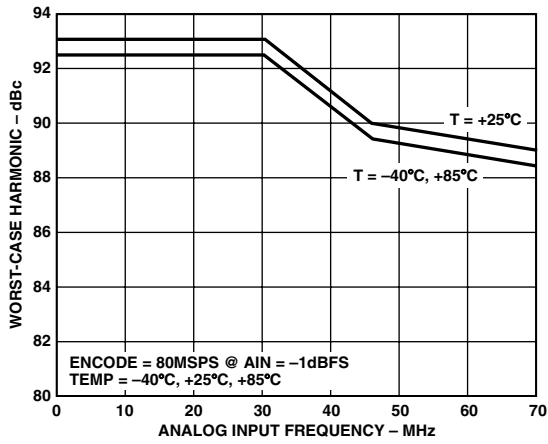
# AD6645



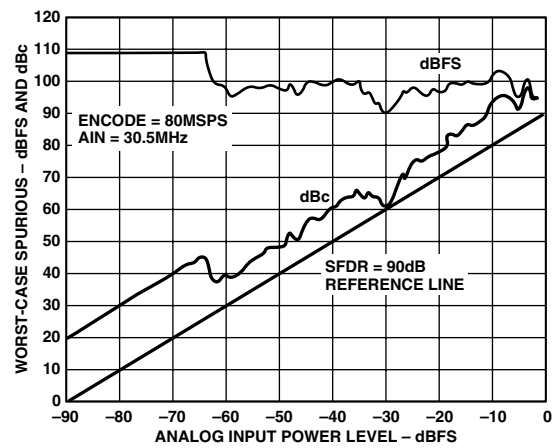
TPC 7. Noise vs. Analog Frequency



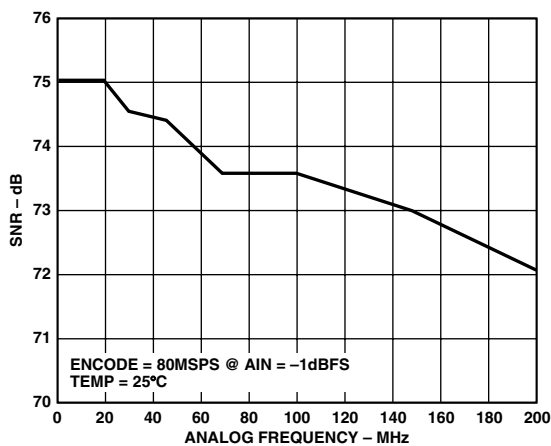
TPC 10. Harmonics vs. Analog Frequency (IF)



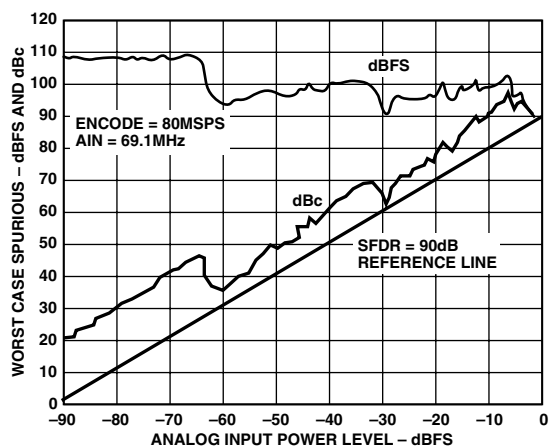
TPC 8. Harmonics vs. Analog Frequency



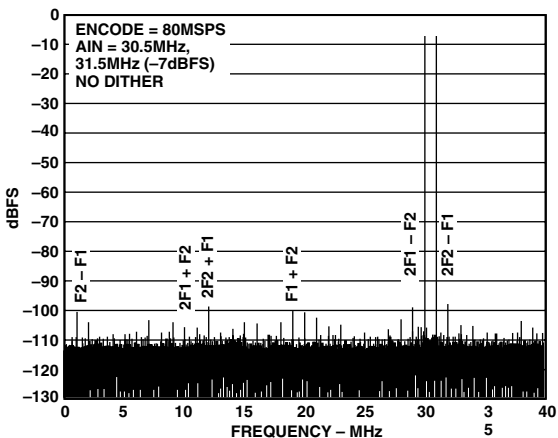
TPC 11. Single Tone SFDR @ 30.5 MHz



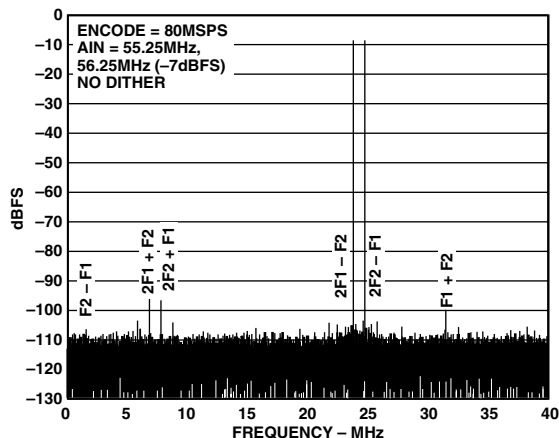
TPC 9. Noise vs. Analog Frequency (IF)



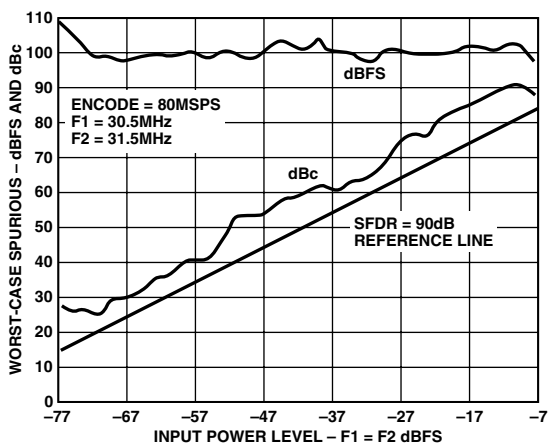
TPC 12. Single Tone SFDR @ 69.1 MHz



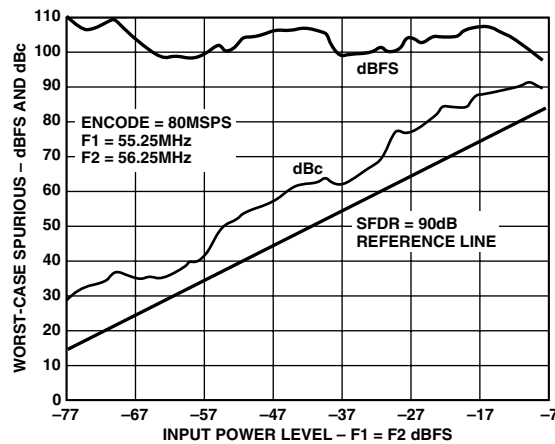
TPC 13. Two Tones @ 30.5 MHz and 31.5 MHz



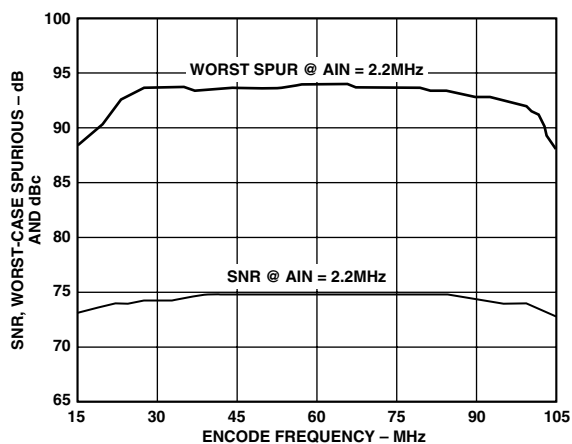
TPC 16. Two Tone SFDR @ 55.25 MHz and 56.25 MHz



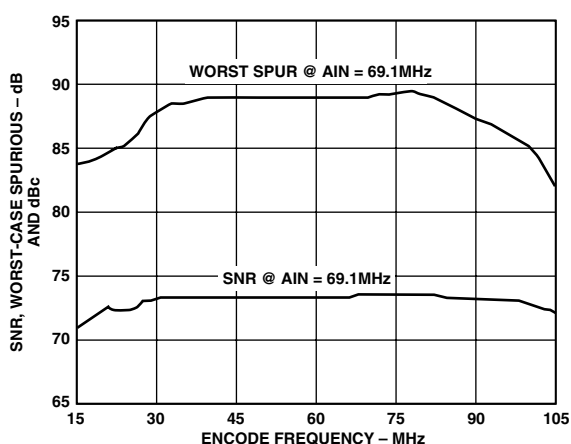
TPC 14. Two Tone SFDR @ 30.5 MHz and 31.5 MHz



TPC 17. Two Tone SFDR @ 55.25 MHz and 56.25 MHz

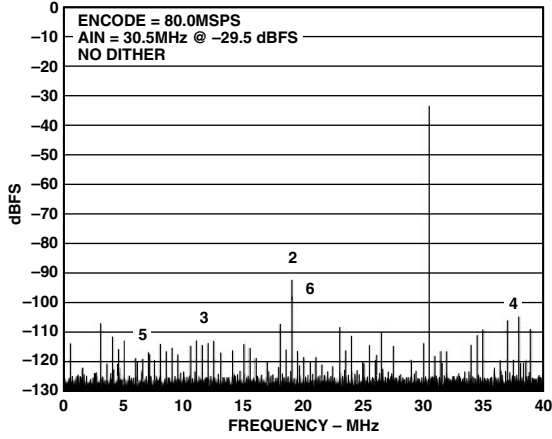


TPC 15. SNR, Worst Spurious vs. Encode @ 2.2 MHz

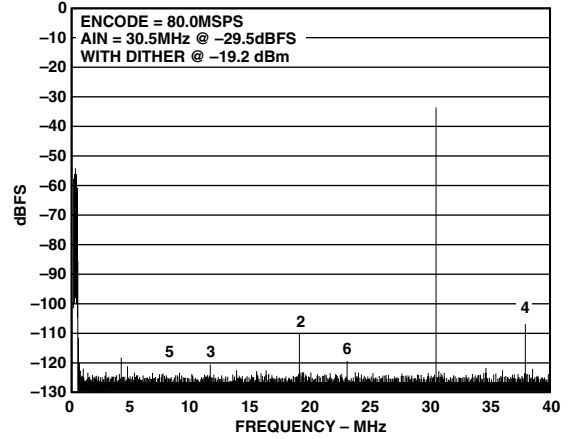


TPC 18. SNR, Worst Spurious vs. Encode @ 69.1 MHz

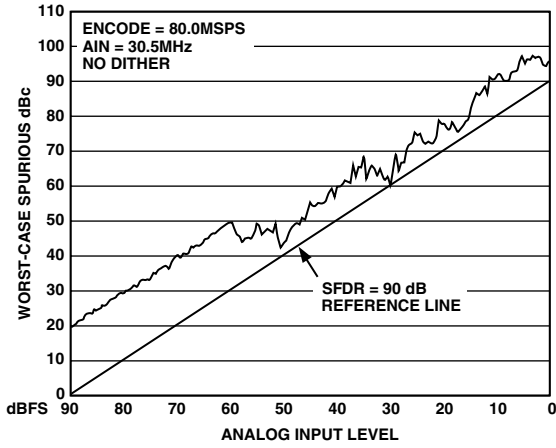
# AD6645



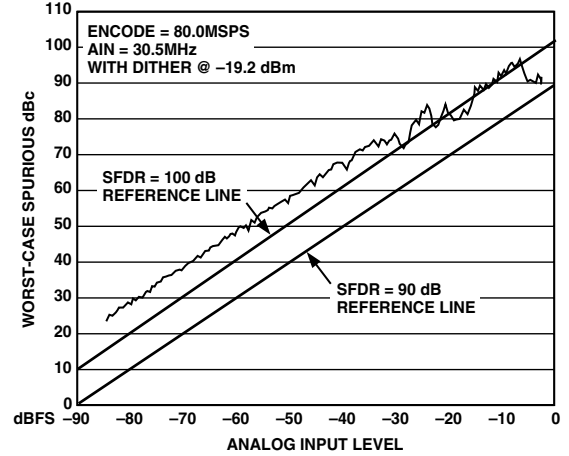
TPC 19. 1 M FFT without Dither



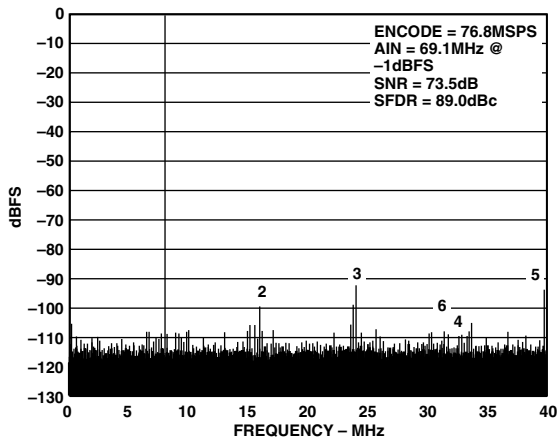
TPC 22. 1 M FFT with Dither



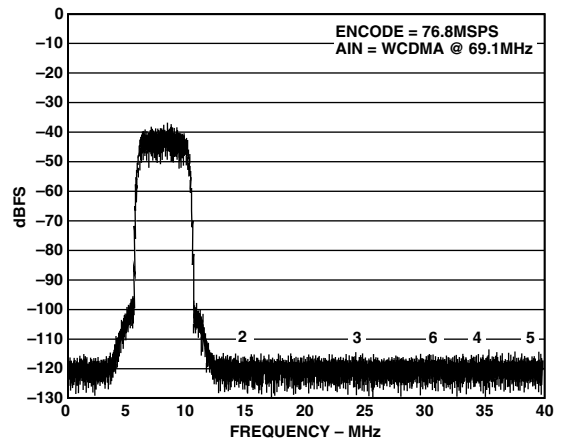
TPC 20. SFDR without Dither



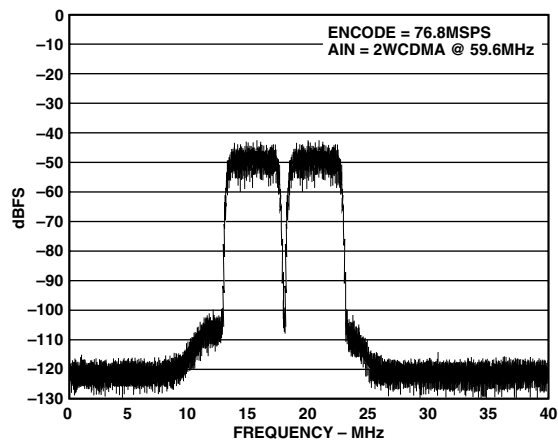
TPC 23. SFDR with Dither



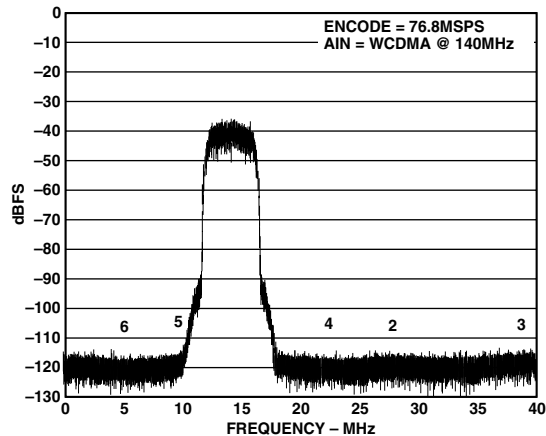
TPC 21. Single Tone 69.1 MHz: Encode = 76.8 MSPS



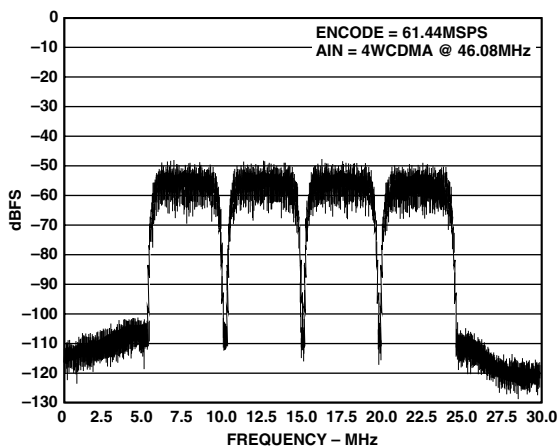
TPC 24. WCDMA Tone 69.1 MHz: Encode = 76.8 MSPS



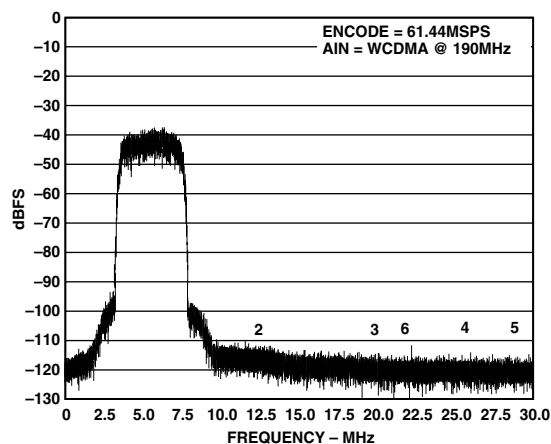
TPC 25. 2 WCDMA Carriers @  $A_{IN} = 59.6$  MHz:  
Encode = 76.8 MSPS



TPC 27. WCDMA Tone 140 MHz: Encode = 76.8 MSPS



TPC 26. 4 WCDMA Carriers @  $A_{IN} = 46.08$  MHz:  
Encode = 61.44 MSPS



TPC 28. WCDMA Tone 190 MHz: Encode = 61.44 MSPS

# AD6645

## THEORY OF OPERATION

The AD6645 analog-to-digital converter (ADC) employs a three-stage subrange architecture. This design approach achieves the required accuracy and speed while maintaining low power and small die size.

As shown in the functional block diagram, the AD6645 has complementary analog input pins,  $A_{IN}$  and  $\overline{A_{IN}}$ . Each analog input is centered at 2.4 V and should swing  $\pm 0.55$  V around this reference (see Figure 2). Since  $A_{IN}$  and  $\overline{A_{IN}}$  are 180 degrees out of phase, the differential analog input signal is 2.2 V p-p.

Both analog inputs are buffered prior to the first track-and-hold, TH1. The high state of the ENCODE pulse places TH1 in hold mode. The held value of TH1 is applied to the input of a 5-bit coarse ADC1. The digital output of ADC1 drives a 5-bit digital-to-analog converter, DAC1. DAC1 requires 14 bits of precision, which is achieved through laser trimming. The output of DAC1 is subtracted from the delayed analog signal at the input of TH3 to generate a first residue signal. TH2 provides an analog pipeline delay to compensate for the digital delay of ADC1.

The first residue signal is applied to a second conversion stage consisting of a 5-bit ADC2, 5-bit DAC2, and pipeline TH4. The second DAC requires 10 bits of precision, which is met by the process with no trim. The input to TH5 is a second residue signal generated by subtracting the quantized output of DAC2 from the first residue signal held by TH4. TH5 drives a final 6-bit ADC3.

The digital outputs from ADC1, ADC2, and ADC3 are added together and corrected in the digital error correction logic to generate the final output data. The result is a 14-bit parallel digital CMOS compatible word, coded as twos complement.

## APPLYING THE AD6645

### Encoding the AD6645

The AD6645 encode signal must be a high quality, extremely low phase noise source to prevent degradation of performance. Maintaining 14-bit accuracy places a premium on encode clock phase noise. SNR performance can easily degrade by 3 dB–4 dB with 70 MHz analog input signals when using a high jitter clock source. See AN-501, *Aperture Uncertainty and ADC System Performance*, for complete details.

For optimum performance, the AD6645 must be clocked differentially. The encode signal is usually ac-coupled into the ENC and  $\overline{ENC}$  pins via a transformer or capacitors. These pins are biased internally and require no additional bias.

Figure 8 shows one preferred method for clocking the AD6645. The clock source (low jitter) is converted from single-ended to differential using an RF transformer. The back-to-back Schottky diodes across the transformer secondary limit clock excursions into the AD6645 to approximately 0.8 V p-p differential. This helps prevent the large voltage swings of the clock from feeding through to other portions of the AD6645, and limits the noise presented to the encode inputs.

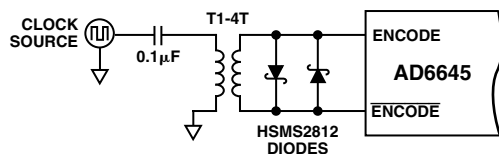


Figure 8. Crystal Clock Oscillator, Differential Encode

If a low jitter clock is available, another option is to ac-couple a differential ECL/PECL signal to the encode input pins as shown in Figure 9. The MC100EL16 (or same family) from ON-SEMI offers excellent jitter performance.

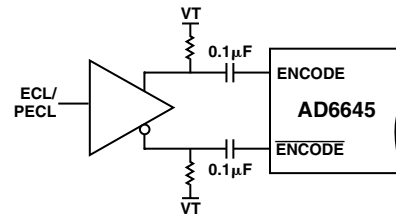


Figure 9. Differential ECL for Encode

### Driving the Analog Inputs

As with most new high speed, high dynamic range analog-to-digital converters, the analog input to the AD6645 is differential. Differential inputs improve on-chip performance as signals are processed through attenuation and gain stages. Most of the improvement is a result of differential analog stages having high rejection of even-order harmonics. There are also benefits at the PCB level. First, differential inputs have high common-mode rejection of stray signals such as ground and power noise. Second, they provide good rejection of common-mode signals such as local oscillator feedthrough.

The AD6645 analog input voltage range is offset from ground by 2.4 V. Each analog input connects through a 500  $\Omega$  resistor to the 2.4 V bias voltage and to the input of a differential buffer (Figure 2). The resistor network on the input properly biases the followers for maximum linearity and range. Therefore, the analog source driving the AD6645 should be ac-coupled to the input pins. Since the differential input impedance of the AD6645 is 1 k $\Omega$ , the analog input power requirement is only –2 dBm, simplifying the driver amplifier in many cases. To take full advantage of this high input impedance, a 20:1 transformer would be required. This is a large ratio and could result in unsatisfactory performance. In this case, a lower step-up ratio could be used. The recommended method for driving the analog input of the AD6645 is to use a 4:1 RF transformer. For example, if  $R_T$  were set to 60.4  $\Omega$  and  $R_S$  were set to 25  $\Omega$ , along with a 4:1 impedance ratio transformer, the input would match to a 50  $\Omega$  source with a full-scale drive of 4.8 dBm. Series resistors ( $R_S$ ) on the secondary side of the transformer should be used to isolate the transformer from the A/D. This will limit the amount of dynamic current from the A/D flowing back into the secondary of the transformer. The 50  $\Omega$  impedance matching can also be incorporated on the secondary side of the transformer as shown in the evaluation board schematic (Figure 13).

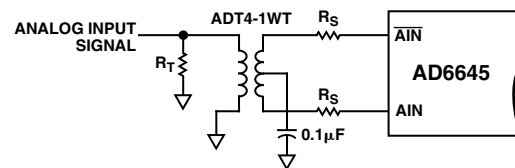


Figure 10. Transformer-Coupled Analog Input Circuit

In applications where dc-coupling is required, a differential output op amp such as the AD8138 from Analog Devices can be used to drive the AD6645 (Figure 11). The AD8138 op amp provides single-ended-to-differential conversion, which reduces overall system cost and minimizes layout requirements.

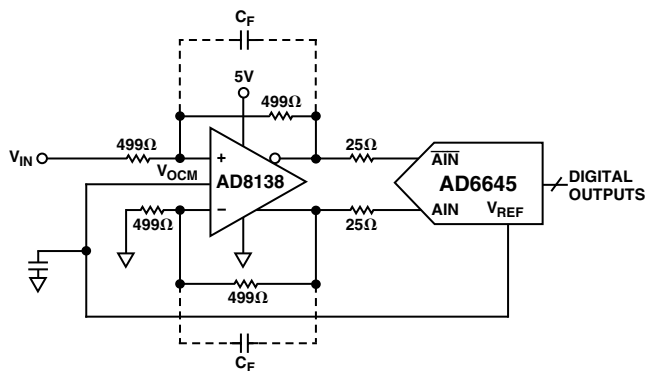


Figure 11. DC-Coupled Analog Input Circuit

### Power Supplies

Care should be taken when selecting a power source. The use of linear dc supplies with rise times of <math><45\text{ ms}</math> is highly recommended. Switching supplies tend to have radiated components that may be received by the AD6645. Each of the power supply pins should be decoupled as closely to the package as possible using  $0.1\text{ }\mu\text{F}</math> chip capacitors.$

The AD6645 has separate digital and analog power supply pins. The analog supplies are denoted  $\text{AV}_{\text{CC}}$  and the digital supply pins are denoted  $\text{DV}_{\text{CC}}$ . Although analog and digital supplies may be tied together, best performance is achieved when the supplies are separate. This is because the fast digital output swings can couple switching current back into the analog supplies. Note that  $\text{AV}_{\text{CC}}$  must be held within 5% of 5 V. The AD6645 is specified for  $\text{DV}_{\text{CC}} = 3.3\text{ V}$ , as this is a common supply for digital ASICs.

### Digital Outputs

Care must be taken when designing the data receivers for the AD6645. It is recommended that the digital outputs drive a series resistor followed by a gate such as the 74LCX574. To minimize capacitive loading, there should only be one gate on each output pin. An example of this is shown in the evaluation board schematic of Figure 13. The digital outputs of the AD6645 have a constant output slew rate of  $1\text{ V/ns}$ . A typical CMOS gate combined with a PCB trace will have a load of approximately  $10\text{ pF}$ . Therefore, as each bit switches  $10\text{ mA}$  ( $10\text{ pF} \times 1\text{ V} \div 1\text{ ns}$ ) of dynamic current per bit will flow in or out of the device. A full-scale transition can cause up to  $140\text{ mA}$  ( $14\text{ bits} \times 10\text{ mA/bit}$ ) of current to flow through the output stages. The series resistors should be placed as close to the AD6645 as possible to limit the amount of current that can flow into the output stage. These switching currents are confined between ground and the  $\text{DV}_{\text{CC}}$  pin. Standard TTL gates should be avoided since they can appreciably add to the dynamic switching currents of the AD6645. It should be noted that extra capacitive loading will increase output timing and invalidate timing specifications. Digital output timing is guaranteed for output loads up to  $10\text{ pF}$ .

Digital output states for given analog input levels are shown in Table I.

Table I. Twos Complement Output Coding

| AIN Level                        | $\overline{\text{AIN}}$ Level    | Output State | Output Code       |
|----------------------------------|----------------------------------|--------------|-------------------|
| $V_{\text{REF}} + 0.55\text{ V}$ | $V_{\text{REF}} - 0.55\text{ V}$ | Positive FS  | 01 1111 1111 1111 |
| $V_{\text{REF}}$                 | $V_{\text{REF}}$                 | Midscale     | 00...0/11...1     |
| $V_{\text{REF}} - 0.55\text{ V}$ | $V_{\text{REF}} + 0.55\text{ V}$ | Negative FS  | 10 0000 0000 0000 |

### Grounding

For optimum performance, it is highly recommended that a common ground be utilized between the analog and digital power planes. The primary concern with splitting grounds is that dynamic currents may be forced to travel significant distances in the system before recombining back at the common source ground. This can result in a large, undesirable ground loop. The most common place for this to occur is on the digital outputs of the ADC. Ground loops can contribute to digital noise being coupled back onto the ADC front end. This can manifest itself as either harmonic spurs, or very high order spurious products that can cause excessive spikes on the noise floor. This noise coupling is less likely to occur at lower clock speeds since the digital noise has more time to settle between samples. In general, splitting the analog and digital grounds can frequently contribute to undesirable EMI-RFI and should therefore be avoided.

Conversely, if not properly implemented, common grounding can actually impose additional noise issues since the digital ground currents are riding on top of the analog ground currents in close proximity to the ADC input. To minimize the potential for noise coupling further, it is highly recommended that multiple ground return traces/vias be placed such that the digital output currents do not flow back towards the analog front end, but are routed quickly away from the ADC. This does not require a split in the ground plane and can be accomplished by simply placing substantial ground connections directly back to the supply at a point between the analog front end and the digital outputs. The judicious use of ceramic chip capacitors between the power supply and ground planes will also help suppress digital noise. The layout should incorporate enough bulk capacitance to supply the peak current requirements during switching periods.

### Layout Information

The schematic of the evaluation board (Figure 13) represents a typical implementation of the AD6645. A multilayer board is recommended to achieve best results. It is highly recommended that high quality, ceramic chip capacitors be used to decouple each supply pin to ground directly at the device. The pinout of the AD6645 facilitates ease of use in the implementation of high frequency, high resolution design practices. All of the digital outputs are segregated to two sides of the chip, with the inputs on the opposite side for isolation purposes.

Care should be taken when routing the digital output traces. To prevent coupling through the digital outputs into the analog portion of the AD6645, minimal capacitive loading should be placed on these outputs. It is recommended that a fan-out of only one gate should be used for all AD6645 digital outputs.

The layout of the encode circuit is equally critical. Any noise received on this circuitry will result in corruption in the digitization process and lower overall performance. The encode clock must be isolated from the digital outputs and the analog inputs.

# AD6645

## Jitter Considerations

The signal-to-noise ratio (SNR) for an ADC can be predicted. When normalized to ADC codes, the equation below accurately predicts the SNR based on three terms. These are jitter, average DNL error, and thermal noise. Each of these terms contributes to the noise within the converter.

$F_{ANALOG}$  = analog input frequency

$t_{j\ rms}$  = rms jitter of the encode (rms sum of encode source and internal encode circuitry)

$\epsilon$  = average DNL of the ADC (typically 0.41 LSB)

$n$  = number of bits in the ADC

$V_{NOISE\ rms}$  = V rms thermal noise referred to the analog input of the ADC (typically 0.9 LSB rms)

For a 14-bit analog-to-digital converter, like the AD6645, aperture jitter can greatly affect the SNR performance as the analog frequency is increased. The chart below shows a family of curves that demonstrate the expected SNR performance of the AD6645 as jitter increases. The chart is derived from the equation below.

For a complete discussion of aperture jitter, see AN-501, *Aperture Uncertainty and ADC System Performance*. The AN-501 Application Note can be found on [www.analog.com](http://www.analog.com).

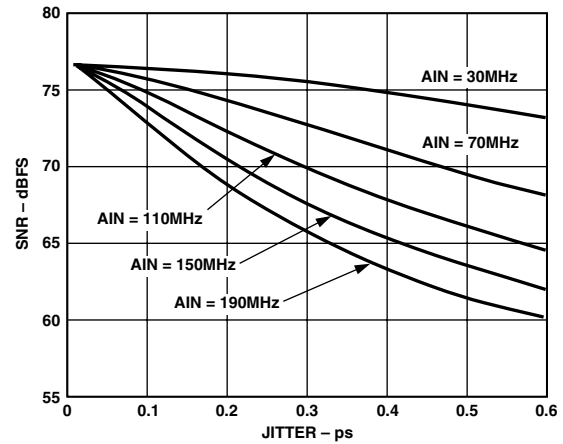


Figure 12. SNR vs. Jitter

$$SNR = 1.76 - 20 \log \left[ \left( 2\pi \times F_{ANALOG} \times t_{j\ rms} \right)^2 + \left( \frac{1 + \epsilon}{2^n} \right)^2 + \left( \frac{2 \times \sqrt{2} \times V_{NOISE\ rms}}{2^n} \right)^2 \right]^{\frac{1}{2}}$$



Table II. AD6645ASQ/PCB Bill of Materials

| Item No. | Qty | Reference ID <sup>1</sup>           | Description  | Manufacturer                            |
|----------|-----|-------------------------------------|--|---|
| 1        | 1   | 6645EE01C                           | AD6644/AD6645 Evaluation Printed Circuit Board                     | PCSM, Inc. (6645EE01C)                  |
| 2        | 3   | C1, C2, C38                         | Capacitor, Tantalum SMT T491C, 10 $\mu$ F; 16 V; 10%               | Kemet (T491C106M016AS)                  |
| 3        | 9   | C3, C7–C11, C16, C30, C32           | Capacitor, SMT 0508, 0.1 $\mu$ F; 16 V; 10%                        | Presidio Components (0508X7R104K16VP6)  |
| 4        | 8   | C4, C22–C26, C29, (C33), (C34), C39 | Capacitor, SMT 0805, 0.1 $\mu$ F; 25 V; 10%                        | Panasonic (ECJ-2VB1E104K)               |
| 5        | 0   | (C5, C6)                            | Capacitor, SMT 0805, 0.01 $\mu$ F; 50 V; 10%                       | Panasonic (ECJ-2YB1H103K)               |
| 6        | 9   | C12–C14, C17–C21, C40               | Capacitor, SMT 0508, 0.01 $\mu$ F; 16 V; 10%                       | Presidio Components (0508X7R103M2P3)    |
| 7        | 1   | CR1                                 | Diode, Schottky Barrier, Dual                                      | Panasonic (MA716-TX)                    |
| 8        | 1   | E3, E4, E5                          | 100" Straight Male Header (Single Row), 3 of 50 Pins               | Samtec (TSW-1-50-08-G-S)                |
| 9        | 4   | F1–F4                               | EMI Suppression Ferrite Chip, SMT 0805                             | Steward (HZ0805E601R-00)                |
| 10       | 1   | J1                                  | Connector, PCB Pin Strip; 5 Pins; 5 mm Pitch                       | Wieland (Z5.530.0525.0)                 |
| 11       | 1   | J1                                  | Connector, PCB Terminal; 5 Pins; 5 mm Pitch                        | Wieland (25.602.2553.0)                 |
| 12       | 1   | J2                                  | Terminal Strip, 50-Pin; Right Angle                                | Samtec (TSW-125-08-T-DRA)               |
| 13       | 0   | (J3)                                | Connector, SMA; RF; Gold   | Johnson Components, Inc. (142-0701-201) |
| 14       | 2   | J4, J5                              | Connector, Coaxial RF Receptacle; 50 $\Omega$                      | AMP (227699-2)                          |
| 15       | 0   | (R1)                                | Resistor, SMT 0402; 100 $\Omega$ ; 1/16 W; 1%                      | Panasonic (ERJ-2RKF1000X)               |
| 16       | 0   | (R2) <sup>2</sup>                   | Resistor, SMT 1206; 60.4 $\Omega$ ; 1/8 W; 1%                      | Panasonic (ERJ-8ENF60R4V)               |
| 17       | 0   | (R3, R4, R5, R8)                    | Resistor, SMT 0805; 499 $\Omega$ ; 1/10 W; 1%                      | Panasonic (ERJ-6ENF4990V)               |
| 18       | 2   | R6, R7                              | Resistor, SMT 0805; 25.5 $\Omega$ ; 1/10 W; 1%                     | Panasonic (ERJ-6ENF25R5V)               |
| 19       | 1   | R9                                  | Resistor, SMT 0805; 348 $\Omega$ ; 1/10 W; 1%                      | Panasonic (ERJ-6ENF3480V)               |
| 20       | 1   | R10                                 | Resistor, SMT 0805; 619 $\Omega$ ; 1/10 W; 1%                      | Panasonic (ERJ-6ENF6190V)               |
| 21       | 0   | (R11), (R13)                        | Resistor, SMT 0805; 66.5 $\Omega$ ; 1/10 W; 1%                     | Panasonic (ERJ-6ENF66R5V)               |
| 22       | 0   | (R12), (R14)                        | Resistor, SMT 0805; 100 $\Omega$ ; 1/10 W; 1%                      | Panasonic (ERJ-6ENF1000V)               |
| 23       | 1   | R15 <sup>2</sup>                    | Resistor, SMT 0402; 178 $\Omega$ ; 1/16 W; 1%                      | Panasonic (ERJ-2RKF1780X)               |
| 24       | 1   | R35                                 | Resistor, SMT 0805; 49.9 $\Omega$ ; 1/10 W; 1%                     | Panasonic (ERJ-6ENF49R9V)               |
| 25       | 2   | RN1, RN3                            | Resistor Array, SMT 0402; 470 $\Omega$ ; 1/4 W; 5%                 | Panasonic (EXB2HV471JV)                 |
| 26       | 2   | RN2, RN4                            | Resistor Array, SMT 0402; 220 $\Omega$ ; 1/4 W; 5%                 | Panasonic (EXB2HV221JV)                 |
| 27       | 1   | T2                                  | RF Transformer, SMT KK81, 0.2–350 MHz; 4:1 $\Omega$ Ratio          | Mini-Circuits (T4-1-KK81)               |
| 28       | 1   | T3                                  | RF Transformer, SMT CD542, 2–775 MHz; 4:1 $\Omega$ Ratio           | Mini-Circuits (ADT4-1WT)                |
| 29       | 1   | U1                                  | I.C., QFP-52; 14-Bit, 80 MSPS Wideband Analog-to-Digital Converter | Analog Devices (AD6645ASQ)              |
| 30       | 2   | U2, U7                              | I.C., SOIC-20; Octal D-Type Flip-Flop                              | Fairchild (74LCX574WM)                  |
| 31       | 0   | (U3)                                | I.C., SOIC-8; Low Distortion Differential ADC Driver               | Analog Devices (AD8138AR)               |
| 32       | 2   | U4, U6                              | I.C., SMT SOT-23; TinyLogic UHS 2-Input OR Gate                    | Fairchild (NC7SZ32)                     |
| 33       | 1   | U5 <sup>3</sup>                     | Clock Oscillator, Full Size MX045; 80 MHz                          | CTS Reeves (MXO45-80)                   |
| 34       | 4   | U5 <sup>3</sup>                     | Connector, Miniature Spring Socket,                                | Amp (5-330808-3)                        |
| 35       | 0   | (U8)                                | I.C., SOIC-8; Differential Receiver                                | Motorola (MC100EL16)                    |
| 36       | 4   | See drawing                         | Circuit Board Support on Base                                      | Richo (CBSB-14-01)                      |
| 37       | 1   | See drawing                         | 0.100" Shorting Block  | Jameco (152670)                         |

## NOTES

<sup>1</sup>Reference designators in parentheses are not installed on standard units. (ac-coupled AIN and ENCODE.)

AC-coupled AIN is standard, R3, R4, R5, R8, and U3 are not installed.

If dc-coupled AIN is required, C30, T3, and R15 are not installed.

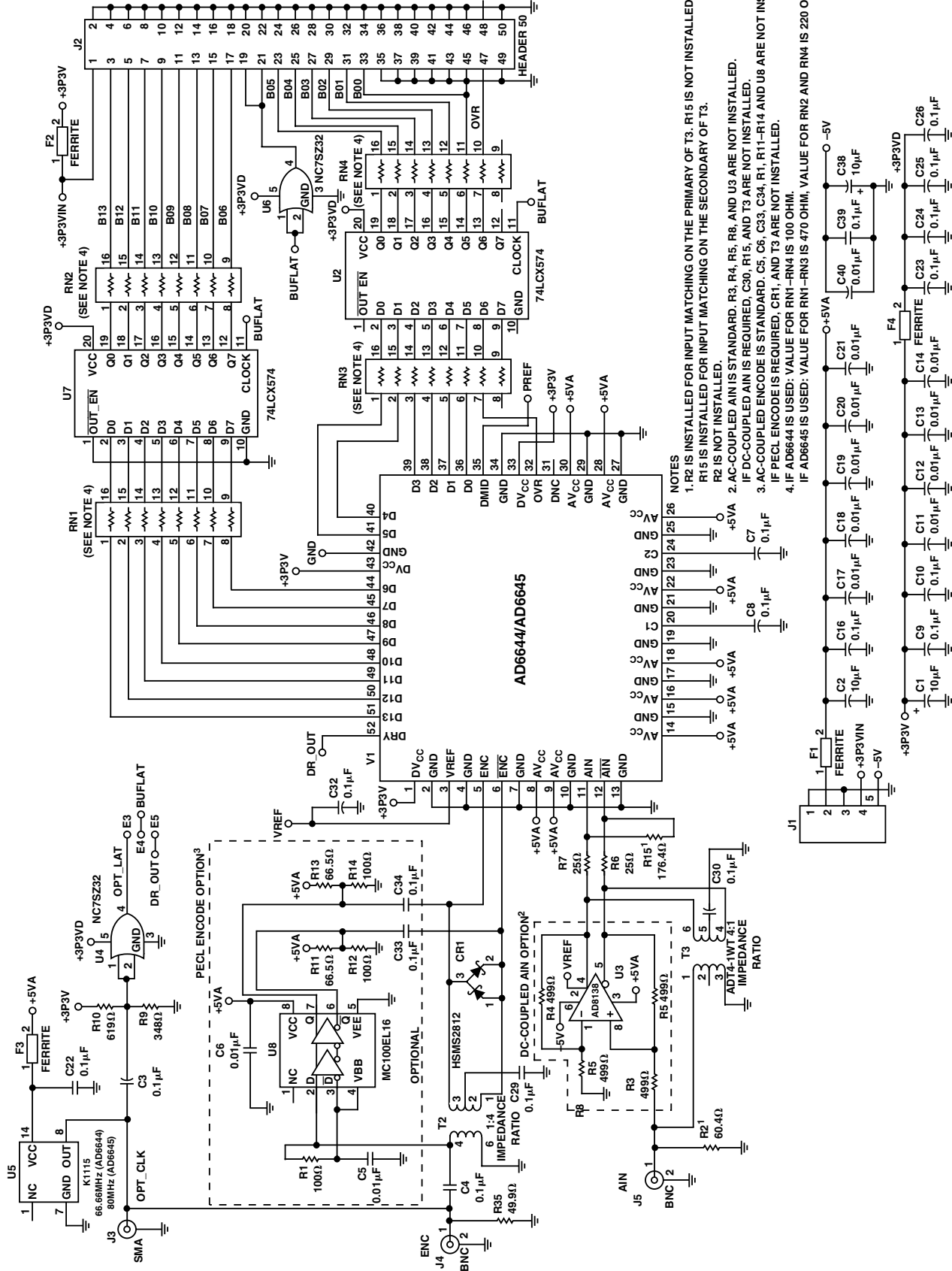
AC-coupled ENCODE is standard. C5, C6, C33, C34, R1, R11–R14, and U8 are not installed.

If PECL ENCODE is required, CR1 and T2 are not installed.

<sup>2</sup>R2 is installed for 50  $\Omega$  impedance input matching on the primary of T3. R15 is not installed.

R15 is installed for 50  $\Omega$  impedance input matching on the secondary of T3. R2 is not installed.

<sup>3</sup>U5 clock oscillator is installed with pin sockets for removal if OPT\_CLK input is used.



- NOTES**
- R2 IS INSTALLED FOR INPUT MATCHING ON THE PRIMARY OF T3. R15 IS NOT INSTALLED. R15 IS NOT INSTALLED FOR INPUT MATCHING ON THE SECONDARY OF T3.
  - R2 IS NOT INSTALLED.
  - AC-COUPLED AIN IS STANDARD. R3, R4, R5, R8, AND U3 ARE NOT INSTALLED. IF DC-COUPLED AIN IS REQUIRED, C30, R15, AND T3 ARE NOT INSTALLED.
  - AC-COUPLED ENCODE IS STANDARD. C5, C6, C33, C34, R1, R11-R14 AND U8 ARE NOT INSTALLED. IF PECL ENCODE IS REQUIRED, CR1, AND T3 ARE NOT INSTALLED.
  - IF AD6644 IS USED: VALUE FOR RN1-RN4 IS 100 OHM. IF AD6645 IS USED: VALUE FOR RN1-RN3 IS 470 OHM, VALUE FOR RN2 AND RN4 IS 220 OHM.

Figure 13. Evaluation Board Schematic

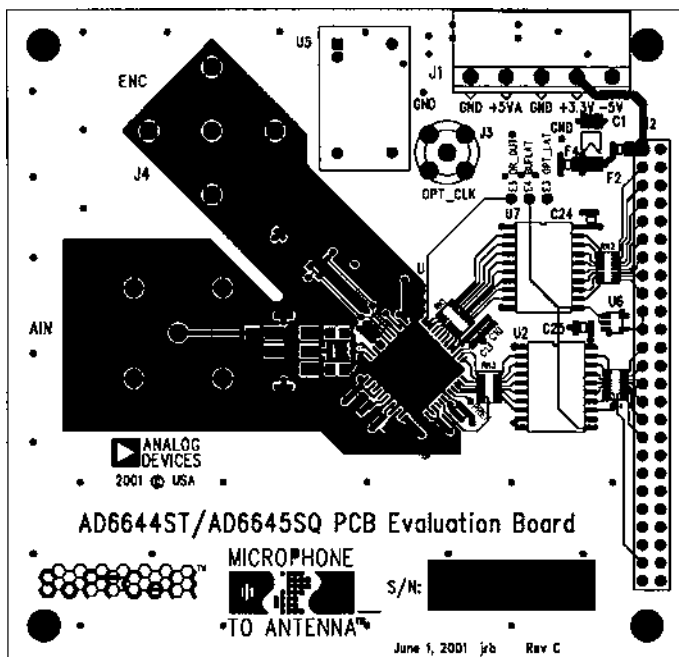


Figure 14. Top Signal Level

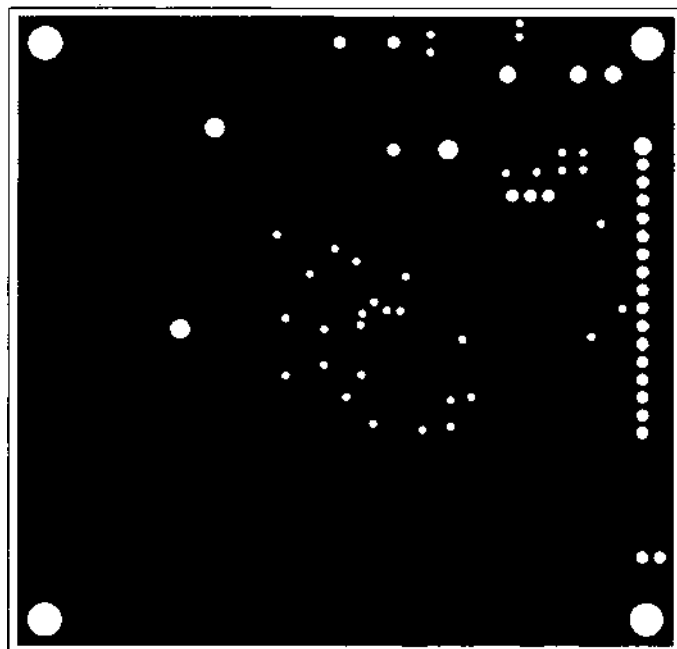


Figure 16. Ground Plane Layer 2 and 5

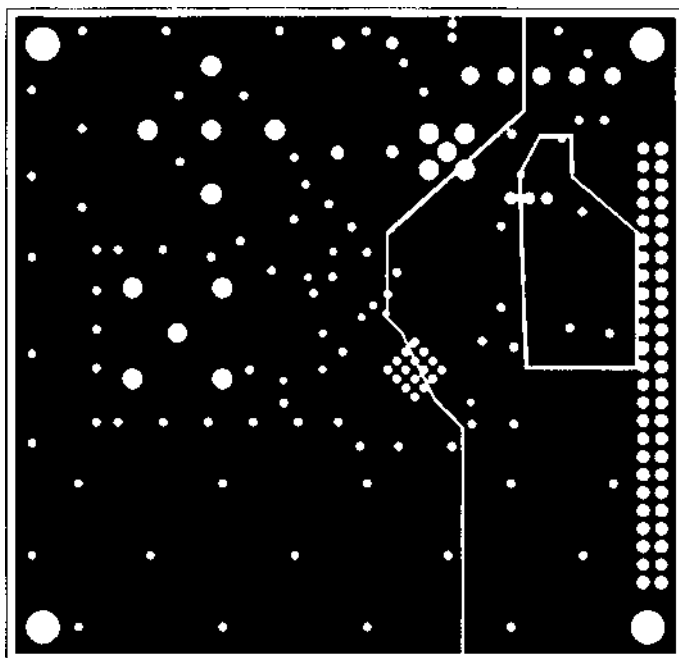


Figure 15. 5.0 V/3.3 V Plane Layers 3 and 4

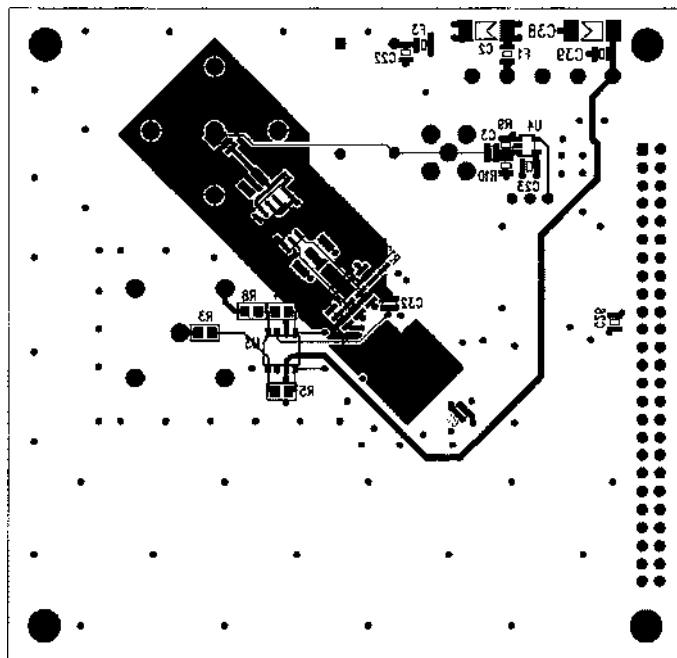
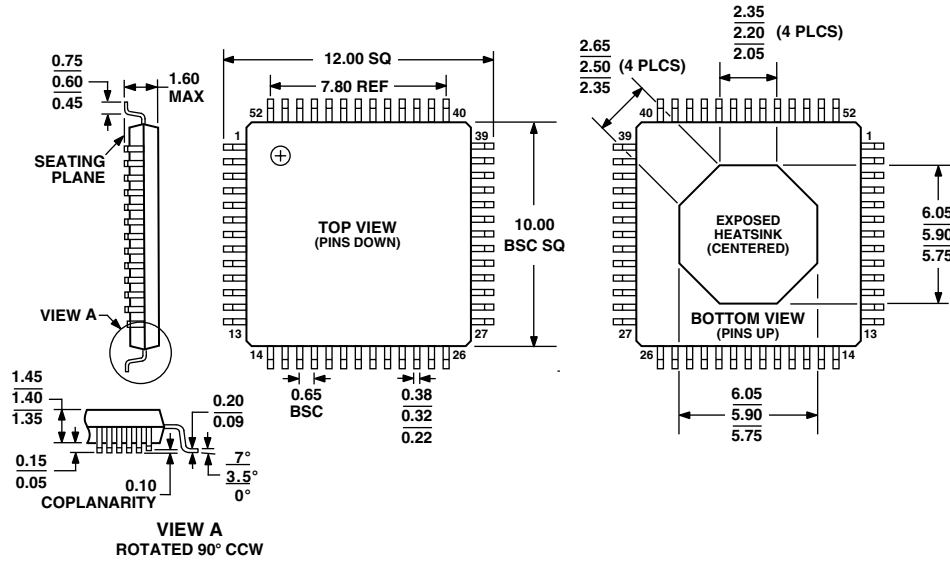


Figure 17. Bottom Signal Layer

OUTLINE DIMENSIONS

52-Lead Low Profile Quad Flat Package, Exposed Pad [LQFP-PQ4]  
(SQ-52)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MS-026BCC-HD

Revision History

| Location  | Page |
|---|------|
| <b>7/03—Data Sheet changed from REV. A to REV. B.</b> |      |
| Changes to Title                                      | 1    |
| Changes to FEATURES                                   | 1    |
| Changes to PRODUCT DESCRIPTION                        | 1    |
| Changes to SPECIFICATIONS                             | 2    |
| Changes to ABSOLUTE MAXIMUM RATINGS                   | 5    |
| Changes to ORDERING GUIDE                             | 5    |
| Updated OUTLINE DIMENSIONS                            | 20   |
| <b>6/02—Data Sheet changed from REV. 0 to REV. A.</b> |      |
| Change to DC SPECIFICATIONS                           | 1    |